632709 <u>7/31</u>/03

Docket No.: 59654 (71987) 08-12-2003 FORM PTO-1595 (Modified) U.S. DEPARTMENT OF COMMERCE (Rev. 03-01) Patent and Trademark Office OMB No. 0651-0027 (exp.5/31/2002) POSA/REVII3 Tab settings → → 102521772 _____ attached original documents or copy thereof. To the Director of the United States Pater 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): **Chien-Ping HUANG** Name: Siliconware Precision Industries Co., Ltd. Yu-Po WANG Address: No. 123, Sec. 3, Da Fong Road, Tantzu, Taichung Hsien, Taiwan, R.O.C. ☐ Yes ☒ No Additional names(s) of conveying party(ies) Nature of conveyance: ☐ Merger City: _____ State/Prov.: ___ ☐ Security Agreement ☐ Change of Name Country: _____ ZIP: _ Other __ Additional name(s) & address(es) Execution Date: ☐ Yes ⊠ No Application number(s) or patent numbers(s): If this document is being filed together with a new application, the execution date of the application is: July 31, 2003 Filing date B. Patent No.(s) Patent Application No. 8/05/2003 LWONDIM1 00000030 10632709 2 FC:8021 40.00 OP ☐ Yes 🖾 No Additional numbers 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: Peter F. Corless 7. Total fee (37 CFR 3.41):....\$ 40.00 Registration No. 33,860 Enclosed - Any excess or insufficiency should be credited or debited to deposit account Address: Edwards & Angell, LLP ☐ Authorized to be charged to deposit account P.O. Box 9169 8. Deposit account number: City: Boston 04-1105 State/Prov.: MA ZIP: 02209 (Attach duplicate copy of this page if paying by deposit account) Country: USA DO NOT USE THIS SPACE Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. July 31, 2003 Peter F. Corless Date Signature Name of Person Signing Total number of pages including cover sheet, attachments, and

Mail documents to be recorded with required cover sheet information to:
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PATENT

REEL: 014356 FRAME: 0577

ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned Inventor(s) (1) Chien-Ping HUANG (2) Yu-Po WANG Full Name(s) Hereby sell, assign and transfer to SILICONWARE PRECISION INDUSTRIES CO., LTD. Assignee Name and Address No. 123, Sec. 3, Da Fong Road, Tantzu, Taichung Hsien , Taiwan, R.O.C. (hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled Title of Invention: SEMICONDUCTOR PACKAGE WITH BUILD-UP LAYERS FORMED ON CHIP AND FABRICATION METHOD OF THE SEMICONDUCTOR PACKAGE Which application was Complete either a) executed by the undersigned on _____ b) filed on the _____ Serial No. Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property. It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee. Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection. TAIWAN, R.O.C. Date Signed at MAY 5, 2003 On Inventor(s) Full Signature(s)

> PATENT REEL: 014356 FRAME: 0578

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 USC 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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